

DATA SHEET

PDTA124E series
PNP resistor-equipped transistors;
 $R1 = 22 \text{ k}\Omega$, $R2 = 22 \text{ k}\Omega$

Product data sheet
Supersedes data of 2003 Apr 14

2004 Aug 02



**PNP resistor-equipped transistors;
R1 = 22 kΩ, R2 = 22 kΩ**

PDTA124E series

FEATURES

- Built-in bias resistors
- Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- General purpose switching and amplification
- Inverter and interface circuits
- Circuit driver.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V_{CEO}	collector-emitter voltage	–	–50	V
I_o	output current (DC)	–	–100	mA
R1	bias resistor	22	–	kΩ
R2	bias resistor	22	–	kΩ

DESCRIPTION

PNP resistor-equipped transistor (see “Simplified outline, symbol and pinning” for package details).

PRODUCT OVERVIEW

TYPE NUMBER	PACKAGE		MARKING CODE	NPN COMPLEMENT
	PHILIPS	EIAJ		
PDTA124EE	SOT416	SC-75	05	PDTC124EE
PDTA124EEF	SOT490	SC-89	3R	PDTC124EEF
PDTA124EK	SOT346	SC-59	05	PDTC124EK
PDTA124EM	SOT883	SC-101	DH	PDTC124EM
PDTA124ES	SOT54 (TO-92)	SC-43	TA124E	PDTC124ES
PDTA124ET	SOT23	–	*05 ⁽¹⁾	PDTC124ET
PDTA124EU	SOT323	SC-70	*05 ⁽¹⁾	PDTC124EU

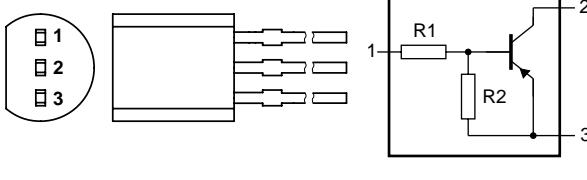
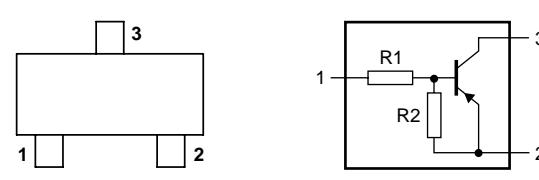
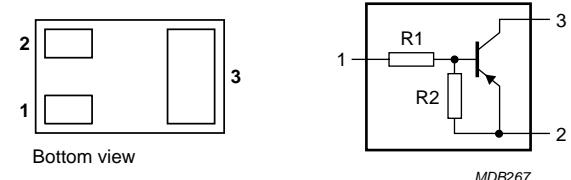
Note

1. * = p: Made in Hong Kong.
- * = t: Made in Malaysia.
- * = W: Made in China.

PNP resistor-equipped transistors;
 $R1 = 22 \text{ k}\Omega$, $R2 = 22 \text{ k}\Omega$

PDTA124E series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PINNING	
		PIN	DESCRIPTION
PDTA124ES	 <p>MAM338</p>	1 2 3	base collector emitter
PDTA124EE PDTA124EEF PDTA124EK PDTA124ET PDTA124EU	 <p>Top view</p> <p>MDB271</p>	1 2 3	base emitter collector
PDTA124EM	 <p>Bottom view</p> <p>MDB267</p>	1 2 3	base emitter collector

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–50	V
V_{CEO}	collector-emitter voltage	open base	–	–50	V
V_{EBO}	emitter-base voltage	open collector	–	–10	V
V_I	input voltage positive negative		– –	+10 –40	V V
I_O	output current (DC)		–	–100	mA
I_{CM}	peak collector current		–	–100	mA
P_{tot}	total power dissipation SOT54 SOT23 SOT346 SOT323 SOT416 SOT490 SOT883	$T_{amb} \leq 25^\circ\text{C}$ note 1 note 1 note 1 note 1 note 1 notes 1 and 2 notes 2 and 3	– – – – – – – –	500 250 250 200 150 250 250	mW mW mW mW mW mW mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C
T_{amb}	operating ambient temperature		–65	+150	°C

Notes

1. Refer to standard mounting conditions.
2. Reflow soldering is the only recommended soldering method.
3. Refer to SOT883 standard mounting conditions; FR4 with 60 µm copper strip line.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient SOT54 SOT23 SOT346 SOT323 SOT416 SOT490 SOT883	in free air note 1 note 1 note 1 note 1 note 1 notes 1 and 2 notes 2 and 3	250 500 500 625 833 500 500	K/W K/W K/W K/W K/W K/W K/W

Notes

1. Refer to standard mounting conditions.
2. Reflow soldering is the only recommended soldering method.
3. Refer to SOT883 standard mounting conditions; FR4 with 60 µm copper strip line.

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PDTA124E series

CHARACTERISTICS

$T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector-base cut-off current	$V_{\text{CB}} = -50 \text{ V}$; $I_E = 0$	—	—	-100	nA
I_{CEO}	collector-emitter cut-off current	$V_{\text{CE}} = -30 \text{ V}$; $I_B = 0$	—	—	-1	μA
		$V_{\text{CE}} = -30 \text{ V}$; $I_B = 0$; $T_j = 150 \text{ }^{\circ}\text{C}$	—	—	-50	μA
I_{EBO}	emitter-base cut-off current	$V_{\text{EB}} = -5 \text{ V}$; $I_C = 0$	—	—	-180	μA
h_{FE}	DC current gain	$V_{\text{CE}} = -5 \text{ V}$; $I_C = -5 \text{ mA}$	60	—	—	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -10 \text{ mA}$; $I_B = -0.5 \text{ mA}$	—	—	-150	mV
$V_{i(\text{off})}$	input-off voltage	$I_C = -100 \mu\text{A}$; $V_{\text{CE}} = -5 \text{ V}$	—	-1.1	-0.8	V
$V_{i(\text{on})}$	input-on voltage	$I_C = -5 \text{ mA}$; $V_{\text{CE}} = -0.3 \text{ V}$	-2.5	-1.7	—	V
$R1$	input resistor		15.4	22	28.6	$\text{k}\Omega$
$\frac{R2}{R1}$	resistor ratio		0.8	1	1.2	
C_c	collector capacitance	$I_E = i_e = 0$; $V_{\text{CB}} = -10 \text{ V}$; $f = 1 \text{ MHz}$	—	—	3	pF

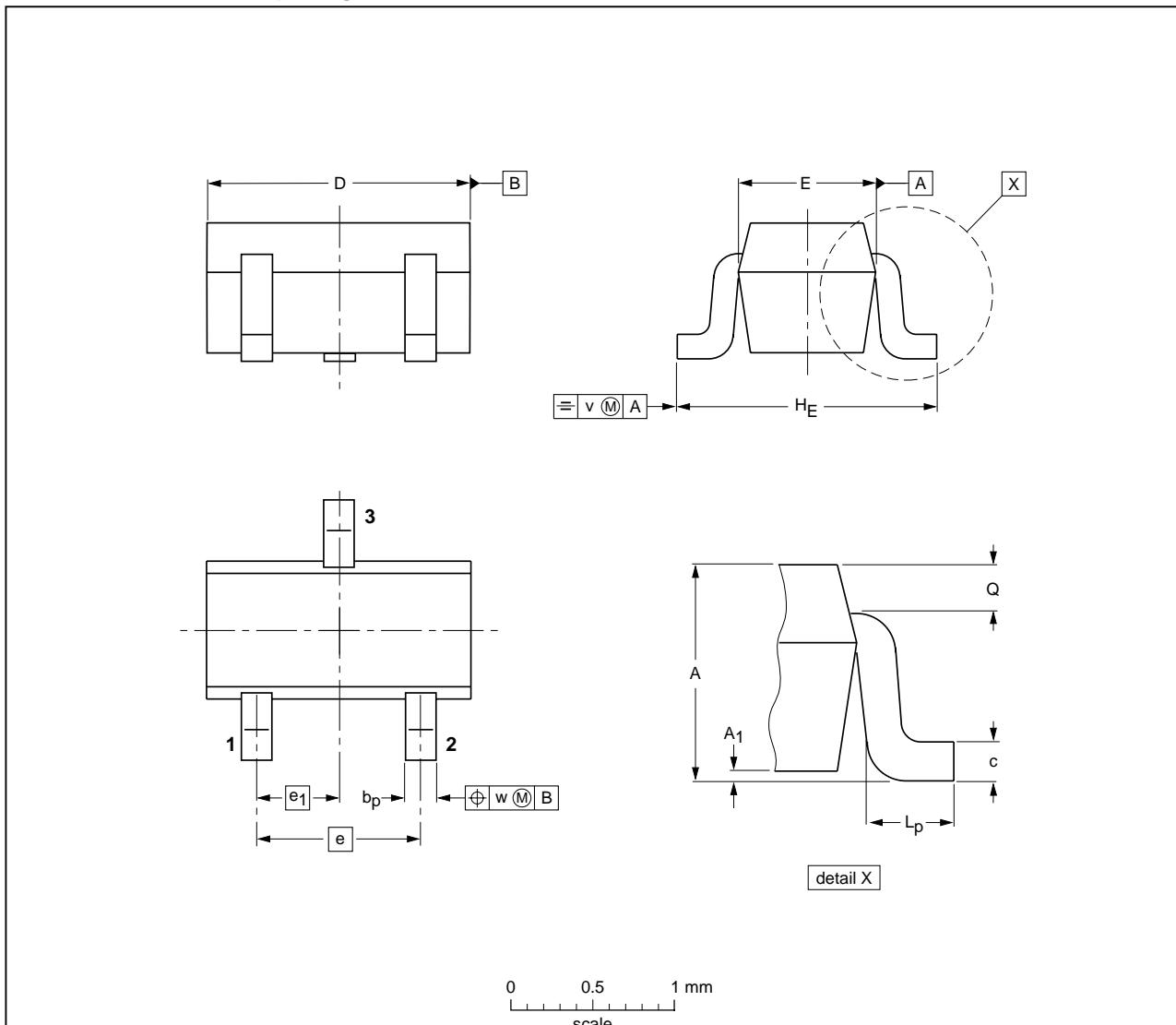
PNP resistor-equipped transistors;
 R1 = 22 kΩ, R2 = 22 kΩ

PDTA124E series

PACKAGE OUTLINES

Plastic surface-mounted package; 3 leads

SOT416



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w
mm	0.95 0.60	0.1	0.30 0.15	0.25 0.10	1.8 1.4	0.9 0.7	1	0.5	1.75 1.45	0.45 0.15	0.23 0.13	0.2	0.2

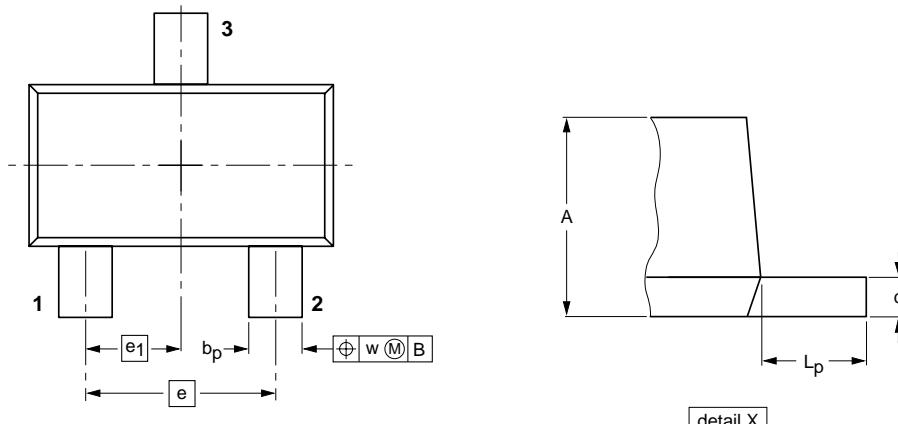
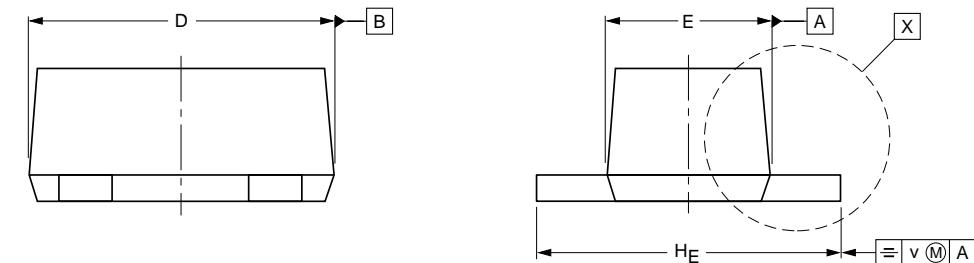
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT416			SC-75			-04-11-04- 06-03-16

PNP resistor-equipped transistors;
 R1 = 22 kΩ, R2 = 22 kΩ

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT490



0 1 2 mm
 scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	b_p	c	D	E	e	e_1	H_E	l_p	v	w
mm	0.8 0.6	0.33 0.23	0.2 0.1	1.7 1.5	0.95 0.75	1.0	0.5	1.7 1.5	0.5 0.3	0.1	0.1

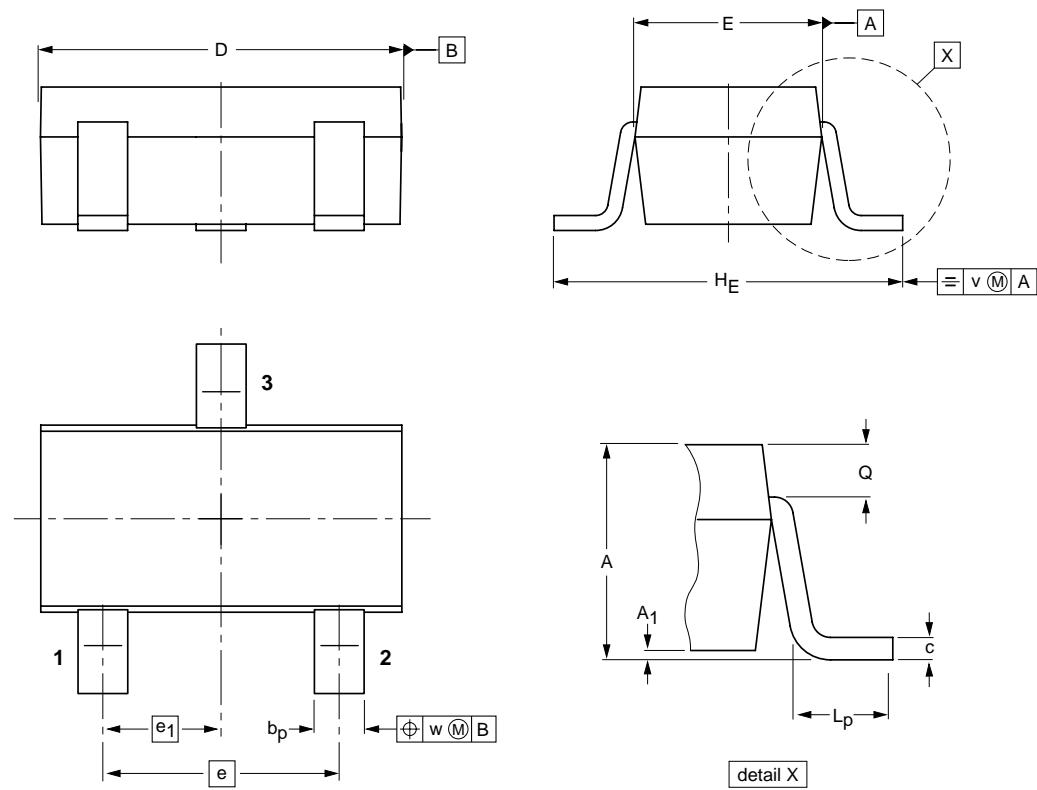
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	IEC	JEDEC	JEITA			
SOT490			SC-89			05-07-28 06-03-16

PNP resistor-equipped transistors;
 R1 = 22 kΩ, R2 = 22 kΩ

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT346



0 1 2 mm
 scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w
mm	1.3 1.0	0.1 0.013	0.50 0.35	0.26 0.10	3.1 2.7	1.7 1.3	1.9	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2

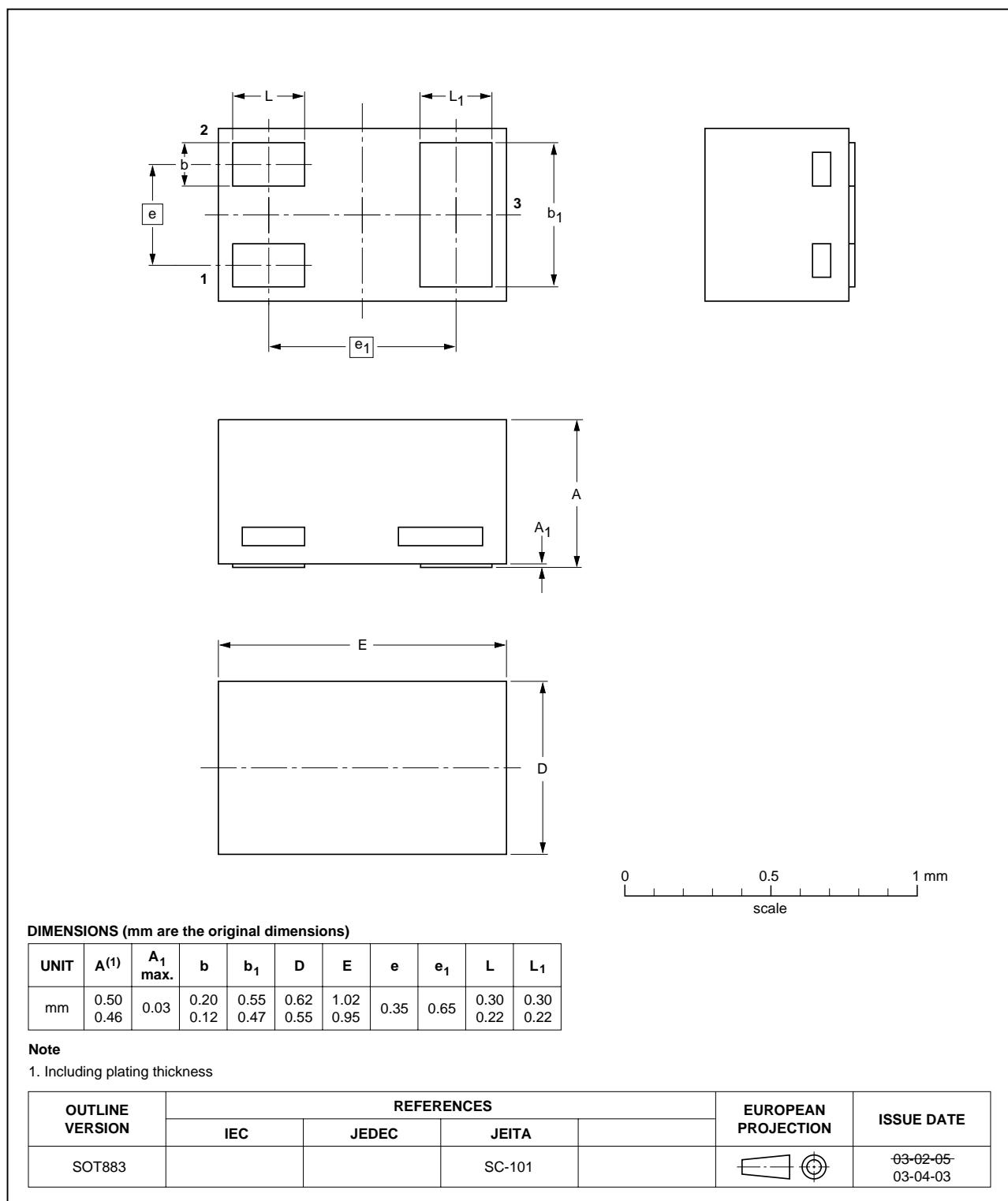
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	IEC	JEDEC	JEITA			
SOT346		TO-236	SC-59A			04-11-11 06-03-16

PNP resistor-equipped transistors;
 R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883

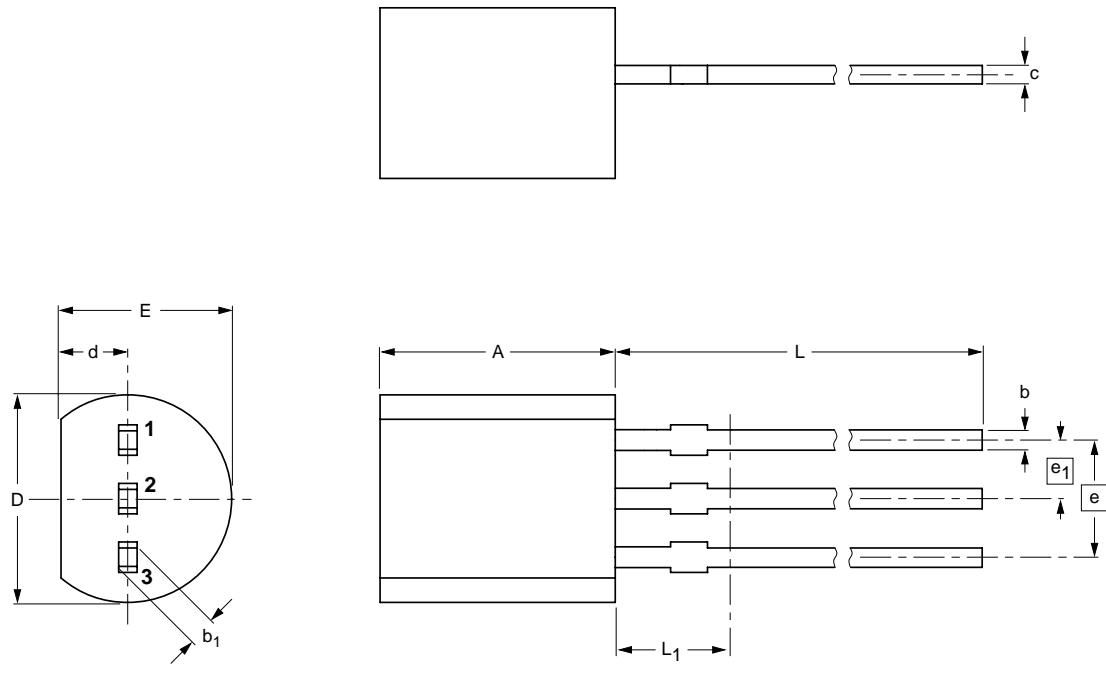


PNP resistor-equipped transistors;
 R1 = 22 kΩ, R2 = 22 kΩ

PDTA124E series

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



0 2.5 5 mm
 scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b ₁	c	D	d	E	e	e ₁	L	L ₁ ⁽¹⁾ max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

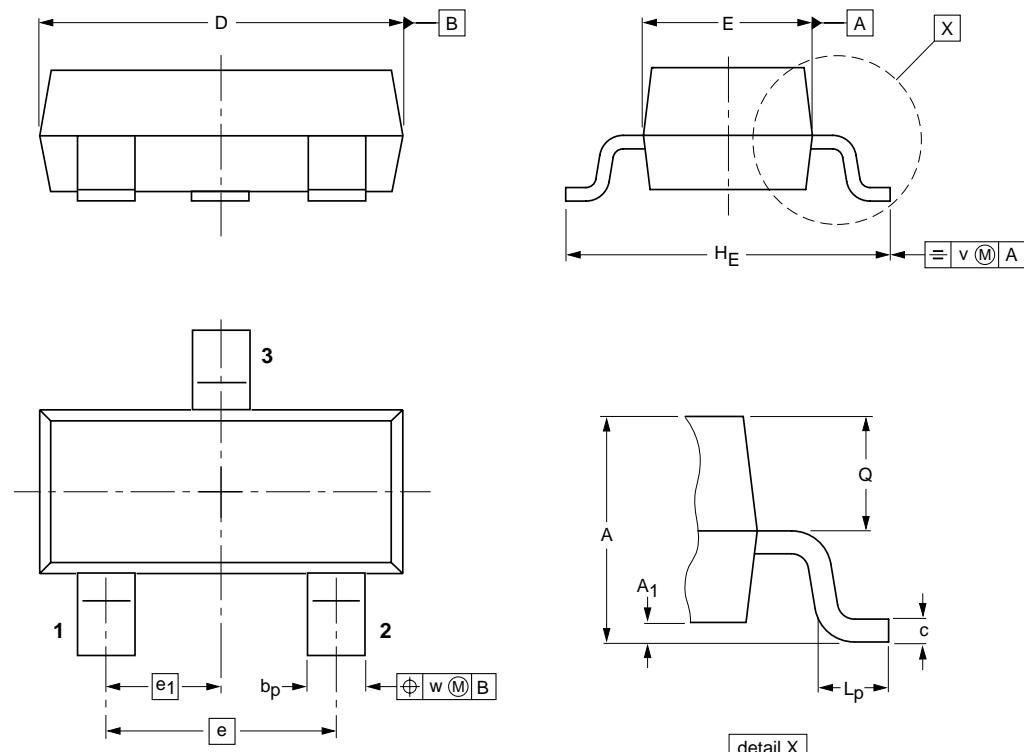
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	IEC	JEDEC	JEITA			
SOT54		TO-92	SC-43A			-04-06-28- 04-11-16

PNP resistor-equipped transistors;
 R1 = 22 kΩ, R2 = 22 kΩ

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT23



0 1 2 mm
 scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max.	b _p	c	D	E	e	e ₁	H _E	l _p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

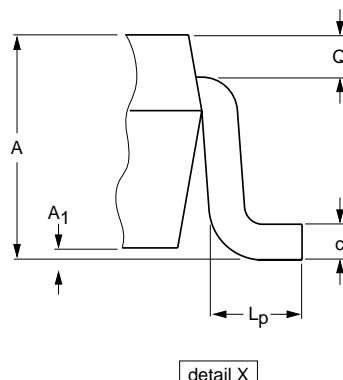
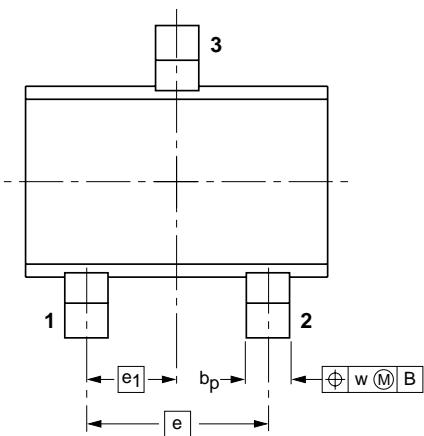
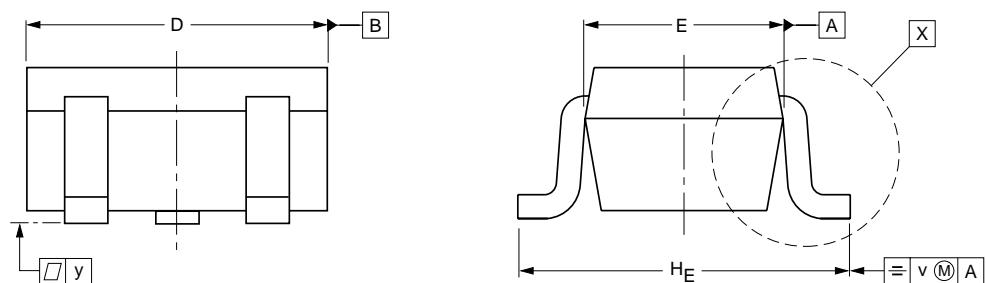
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT23		TO-236AB				-04-11-04- 06-03-16

PNP resistor-equipped transistors;
 R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT323



0 1 2 mm
 scale

DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w
mm	1.1 0.8	0.1	0.4 0.3	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.23 0.13	0.2	0.2

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT323			SC-70			-04-11-04- 06-03-16

PNP resistor-equipped transistors;
 R1 = 22 kΩ, R2 = 22 kΩ

PDTA124E series

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

1. Please consult the most recently issued document before initiating or completing a design.
2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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